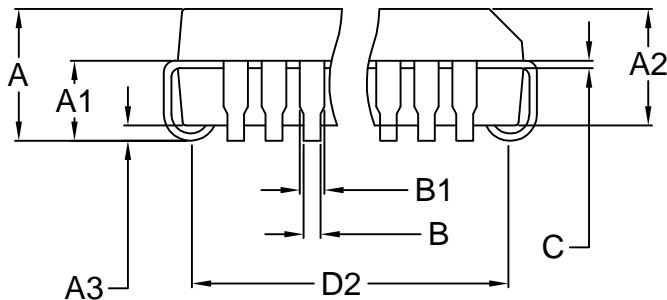


	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.165	0.180	4.20	4.57
A1	0.090	0.120	2.29	3.04
A2	0.145	0.156	3.69	3.96
A3	0.020	---	0.51	---
B	0.013	0.021	0.33	0.53
B1	0.026	0.032	0.66	0.81
C	0.009	0.011	0.23	0.28
e	0.050		1.27	



	INCHES		MILLIMETERS		N	M0047
	MIN	MAX	MIN	MAX		
D	0.385	0.395	9.78	10.03	20	AA
D1	0.350	0.356	8.89	9.04		
D2	0.290	0.330	7.37	8.38		
D3	0.200	REF	5.08	REF		

D	0.485	0.495	12.32	12.57	28	AB
D1	0.450	0.456	11.43	11.58		
D2	0.390	0.430	9.91	10.92		
D3	0.300	REF	7.62	REF		



D	0.685	0.695	17.40	17.65	44	AC
D1	0.650	0.656	16.51	16.66		
D2	0.590	0.630	14.99	16.00		
D3	0.500	REF	12.70	REF		

D	0.785	0.795	19.94	20.19	52	AD
D1	0.750	0.756	19.05	19.20		
D2	0.690	0.730	17.53	18.54		
D3	0.600	REF	15.24	REF		

D	0.985	0.995	25.02	25.27	68	AE
D1	0.950	0.958	24.13	24.33		
D2	0.890	0.930	22.61	23.62		
D3	0.800	REF	20.32	REF		

NOTES:

1. D1 DOES NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .20mm (.008") PER SIDE.
3. LEADS TO BE COPLANAR WITHIN .10mm.
4. CONTROLLING DIMENSION: MILLIMETER
5. MEETS JEDEC MO047-XX AS SHOWN IN TABLE.
6. N = NUMBER OF PINS.

 DALLAS SEMICONDUCTOR					
PROPRIETARY INFORMATION					
TITLE: FAMILY PACKAGE OUTLINE: 20L, 28L, 44L, 52L, 68L PLCC					
APPROVAL	DOCUMENT CONTROL NO. 21-0049	REV. D	1	1	1